# SIM Card EMI Filter Array with ESD Protection

#### **Product Description**

The CM1402 is an EMI filter array with ESD protection, which integrates three pi filters (C–R–C) and two additional channels of ESD protection. The CM1402 has component values of 20 pF – 47  $\Omega$  – 20 pF, and 20 pF – 100  $\Omega$  – 20 pF. The parts include avalanche–type ESD diodes on every pin, which provide a very high level of protection for sensitive electronic components that may be subjected to electrostatic discharge (ESD). The ESD diodes connected to the filter ports are designed and characterized to safely dissipate ESD strikes of ±10 kV, beyond the maximum requirement of the IEC 61000–4–2 international standard. Using the MIL–STD–883 (Method 3015) specification for Human Body Model (HBM) ESD, the pins are protected for contact discharges at greater than ±25 kV.

The ESD diodes on pins A4 and C4 ports are designed and characterized to safely dissipate ESD strikes of  $\pm 10$  kV, well beyond the maximum requirement of the IEC 61000-4-2 international standard.

This device is particularly well suited for portable electronics (e.g. mobile handsets, PDAs, notebook computers) because of its small package format and easy-to-use pin assignments. In particular, the CM1402 is ideal for EMI filtering and protecting data lines from ESD for the SIM card slot in mobile handsets.

The CM1402 incorporates *OptiGuard*<sup>imessilon</sup> coating which results in improved reliability at assembly. The CM1402 is available in a space-saving, low-profile Chip Scale Package.

#### Features

- Functionally and Pin-Compatible with CSPEMI400 Device
- *OptiGuard*<sup>™</sup> Coated for Improved Reliability at Assembly
- Three Channels of EMI Filtering, Each with ESD Protection
- Two Additional Channels of ESD-Only Protection
- ±10 kV ESD Protection (IEC 61000-4-2, Contact Discharge) on All Pins
- ±25 kV ESD Protection (HBM)
- Greater than 30 dB of Attenuation at 1 GHz
- 10-Bump, 1.960 mm x 1.330 mm Footprint Chip Scale Package (CSP)
- Chip Scale Package Features Extremely Low Lead Inductance for Optimum Filter and ESD Performance
- These Devices are Pb-Free and are RoHS Compliant

# Applications

- SIM Card Slot in Mobile Handsets
- I/O Port Protection for Mobile Handsets, Notebook Computers, PDAs, etc.
- EMI Filtering for Data Ports in Cell Phones, PDAs or Notebook Computers



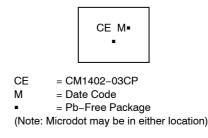
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WLCSP10 CP SUFFIX CASE 567BL

### MARKING DIAGRAM

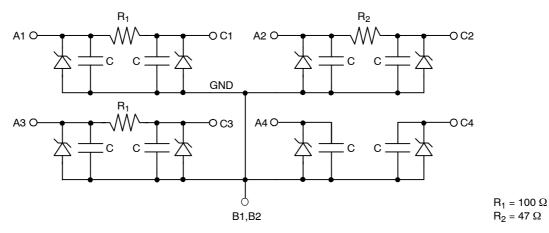


#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
CM1402-03CP	CSP-10 (Pb-Free)	3500/Tape & Reel
	(PD-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

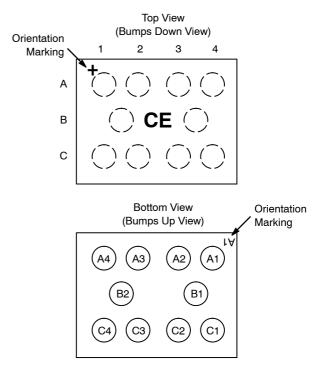
#### **ELECTRICAL SCHEMATIC**



#### Table 1. PIN DESCRIPTIONS

10-bump CSP Package				
Туре	Pin	Description		
EMI Filter	A1	EMI Filter with ESD Protection for RST Signal		
	C1	EMI Filter with ESD Protection for RST Signal		
EMI Filter	A2	EMI Filter with ESD Protection for CLK Signal		
	C2	EMI Filter with ESD Protection for CLK Signal		
Device Ground	B1	Device Ground		
Ground	B2	Device Ground		
EMI Filter	AЗ	EMI Filter with ESD Protection for DAT Signal		
	СЗ	EMI Filter with ESD Protection for DAT Signal		
ESD Channel	A4	ESD Protection Channel – V <sub>CC</sub> Supply		
ESD Channel	C4	ESD Protection Channel		

#### PACKAGE / PINOUT DIAGRAMS



CM1402 CSP Package with OptiGuard coating

#### **SPECIFICATIONS**

#### **Table 2. ABSOLUTE MAXIMUM RATINGS**

Parameter	Rating	Units
Storage Temperature Range	65 to +150	°C
DC Power per Resistor	100	mW
DC Package Power Rating	300	mW

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### **Table 3. STANDARD OPERATING CONDITIONS**

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C

# Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

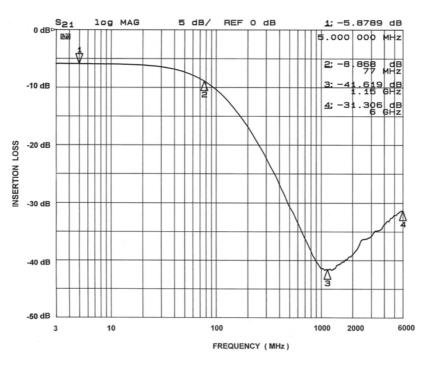
Symbol	Parameter	Conditions	Min	Тур	Max	Units
R <sub>1</sub>	Resistance of R <sub>1</sub>		80	100	120	Ω
R <sub>2</sub>	Resistance of R <sub>2</sub>		38	47	56	Ω
С	Capacitance	VIN = 2.5 VDC, 1 MHz, 30 mV ac	16	20	24	pF
V <sub>STANDOFF</sub>	Stand-off Voltage	I = 10 μA		6.0		V
I <sub>LEAK</sub>	Diode Leakage Current	V <sub>BIAS</sub> = 3.3 V		0.1	1.0	μΑ
V <sub>SIG</sub>	Signal Voltage Positive Clamp Negative Clamp	I <sub>LOAD</sub> = 10 mA I <sub>LOAD</sub> = -10 mA	5.6 -1.5	6.8 0.8	9.0 -0.4	V
V <sub>ESD</sub>	In–system ESD Withstand Voltage a) Human Body Model, MIL–STD–883, Method 3015 b) Contact Discharge per IEC 61000–4–2	(Notes 2 and 4)	±25 ±10			kV
V <sub>CL</sub>	Clamping Voltage during ESD Discharge MIL–STD–883 (Method 3015), 8 kV Positive Transients Negative Transients	(Notes 2, 3 and 4)			+12 _7	V
f <sub>C1</sub>	Cut–off Frequency $Z_{SOURCE}$ = 50 $\Omega$ , $Z_{LOAD}$ = 50 $\Omega$	R = 100 Ω, C = 20 pF		77		MHz
f <sub>C2</sub>	Cut–off Frequency $Z_{SOURCE}$ = 50 $\Omega$ , $Z_{LOAD}$ = 50 $\Omega$	R = 47 Ω, C = 20 pF		85		MHz

T<sub>A</sub> = 25°C unless otherwise specified.
ESD applied to input and output pins with respect to GND, one at a time.
Clamping voltage is measured at the opposite side of the EMI filter to the ESD pin. For example, if ESD is applied to Pin A1, then clamping voltage is measured at Pin C1.

4. Unused pins are left open.

# **PERFORMANCE INFORMATION**

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ω Environment)





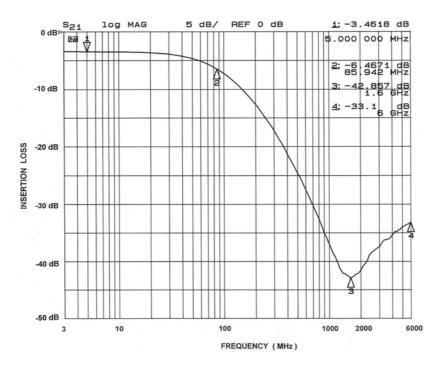
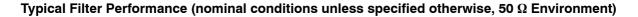
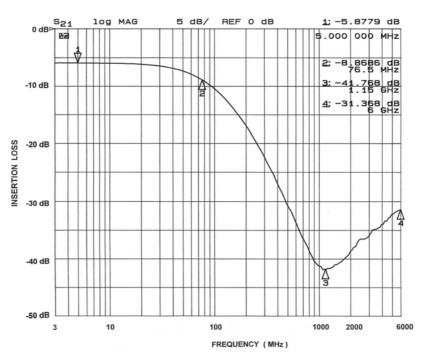


Figure 2. A2–C2 EMI Filter Performance

# PERFORMANCE INFORMATION (Cont'd)







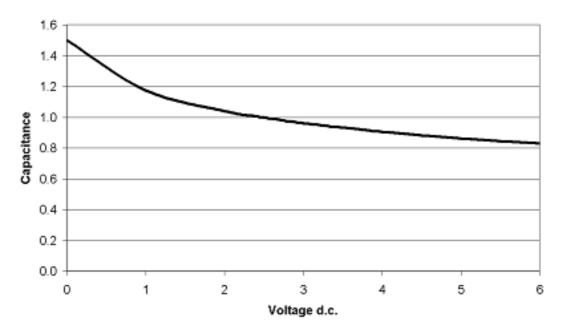
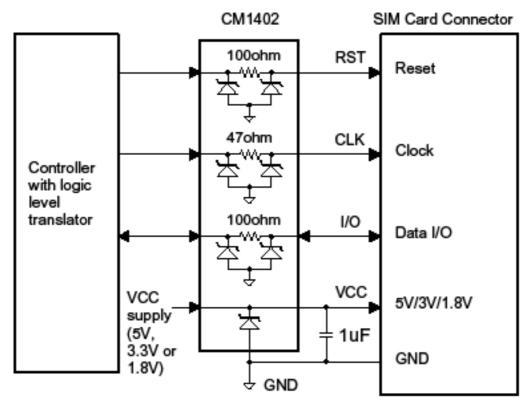


Figure 4. Typical Diode Capacitance vs. Input Voltage (normalized to 2.5 VDC)

# **APPLICATION INFORMATION**

The CM1402 provides a bidirectional filter and protector for all the signals and the power line on the SIM (subscriber identity module) card connector. SIM cards are found in all GSM cellular phones and in some other handheld devices or card readers. The ESD diodes protect the controller against possible ESD strikes that may occur when the connector pins are exposed during direct contact, or during insertion of the SIM card into the card slot. The EMI filter suppresses all high–frequency noise, preventing the unwanted EMI signals from both entering and exiting the main board. The signals that interface with the SIM card are the Reset, the Clock and the bidirectional data I/O, as shown in Typical Application Diagram for the SIM Card Interface.



Note: One channel of the CM1402 with a zener diode is not shown on the diagram.

#### Figure 5. Typical Application Diagram for the SIM Card Interface

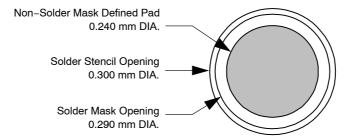
For best filter and ESD performance, both GND bumps (B1, B2) of the CM1402 should be directly connected to the Ground plane. A small capacitor of about 1  $\mu$ F is required next to the V<sub>CC</sub> pin of the SIM connector in order to improve stability of the SIM card supply rail.

For information on the assembly of the CM1402 to the PCB (printed circuit board), please refer to the Chip Scale Package (CSP) Application Note AP217, or contact factory at 800–282–9855 for technical support.

### **APPLICATION INFORMATION**

#### Table 5. PRINTED CIRCUIT BOARD RECOMMENDATIONS

Parameter	Value	
Pad Size on PCB	0.240 mm	
Pad Shape	Round	
Pad Definition	Non-Solder Mask defined pads	
Solder Mask Opening	0.290 mm Round	
Solder Stencil Thickness	0.125 – 0.150 mm	
Solder Stencil Aperture Opening (laser cut, 5% tapered walls)	0.300 mm Round	
Solder Flux Ratio	50/50 by volume	
Solder Paste Type	No Clean	
Pad Protective Finish	OSP (Entek Cu Plus 106A)	
Tolerance – Edge To Corner Ball	±50 μm	
Solder Ball Side Coplanarity	±20 μm	
Maximum Dwell Time Above Liquidous (183°C)	60 seconds	
Maximum Soldering Temperature for Lead-free Devices using a Lead-free Solder Paste	260°C	





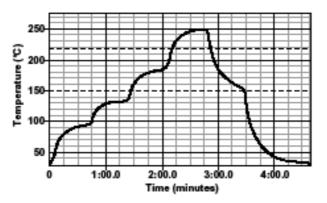
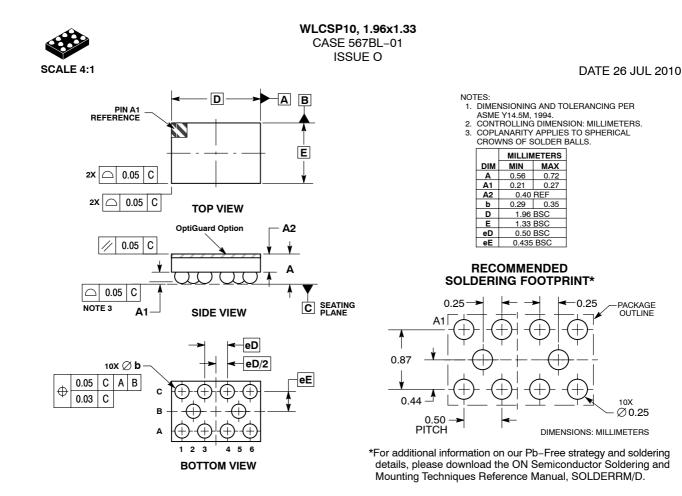


Figure 7. Lead-free (SnAgCu) Solder Ball Reflow Profile

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